

PJT7604-AU

30V Complementary Enhancement Mode MOSFET - ESD Protected

Voltage

30 / -30 V

Current

300 / -300 mA

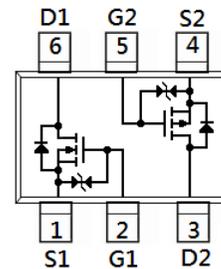
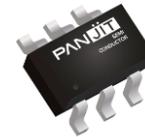
SOT-363

Features

- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc
- ESD Protected
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case : SOT-363 Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.006 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	N-Ch LIMIT	P-Ch LIMIT	UNITS
Drain-Source Voltage		V _{DS}	30	-30	V
Gate-Source Voltage		V _{GS}	+10		
Continuous Drain Current (Note 5)		I _D	300	-300	mA
Pulsed Drain Current (Note 1)		I _{DM}	600	-600	
Power Dissipation	T _a =25°C	P _D	350		mW
	Derate above 25°C		2.8		mW/°C
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55~150		°C
Thermal resistance		R _{θJA}	357		°C/W
- Junction to Ambient (Note 5)					

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N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	0.4	0.75	1	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =300mA	-	0.7	1.2	Ω
		V _{GS} =2.5V, I _D =200mA	-	0.8	1.6	
		V _{GS} =1.8V, I _D =100mA	-	0.9	2	
		V _{GS} =1.5V, I _D =50mA	-	1.1	3	
		V _{GS} =1.2V, I _D =20mA	-	1.5	4	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±10V, V _{DS} =0V	-	-	±10	uA
Dynamic (Note 5)						
Total Gate Charge	Q _g	V _{DS} =10V, I _D =300mA, V _{GS} =4.5V (Note 2,3)	-	0.9	-	nC
Gate-Source Charge	Q _{gs}		-	0.3	-	
Gate-Drain Charge	Q _{gd}		-	0.2	-	
Input Capacitance	C _{iss}	V _{DS} =10V, V _{GS} =0V, f=1MHz	-	45	-	pF
Output Capacitance	C _{oss}		-	14	-	
Reverse Transfer Capacitance	C _{rss}		-	0.8	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} =10V, I _D =300mA, V _{GS} =4V, R _G =10Ω (Note 2,3)	-	8.3	-	ns
Turn-On Rise Time	t _r		-	5.7	-	
Turn-Off Delay Time	t _{d(off)}		-	35	-	
Turn-Off Fall Time	t _f		-	12	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I _S	---	-	-	300	mA
Diode Forward Voltage	V _{SD}	I _S = 300mA, V _{GS} =0V		0.9	1.3	V

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P-Channel Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-30	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4	-0.76	-1	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-500mA$	-	1.6	2.5	Ω
		$V_{GS}=-2.5V, I_D=-200mA$	-	2	3	
		$V_{GS}=-1.8V, I_D=-100mA$	-	2.5	4	
		$V_{GS}=-1.5V, I_D=-40mA$	-	3	6	
		$V_{GS}=-1.2V, I_D=-10mA$	-	5	8	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V, V_{GS}=0V$	-	-	-1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 10V, V_{DS}=0V$	-	-	± 10	
Dynamic (Note 5)						
Total Gate Charge	Q_g	$V_{DS}=-10V, I_D=-300mA,$ $V_{GS}=-4.5V$ (Note 2,3)	-	0.92	-	nC
Gate-Source Charge	Q_{gs}		-	0.16	-	
Gate-Drain Charge	Q_{gd}		-	0.06	-	
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V,$ $f=1MHz$	-	48	-	pF
Output Capacitance	C_{oss}		-	14	-	
Reverse Transfer Capacitance	C_{rss}		-	4	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=-10V, I_D=-300mA,$ $V_{GS}=-4.5V,$ $R_G=10\Omega$ (Note 2,3)	-	23	-	ns
Turn-On Rise Time	t_r		-	37	-	
Turn-Off Delay Time	$t_{d(off)}$		-	80	-	
Turn-Off Fall Time	t_f		-	98	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I_S	---	-	-	-250	mA
Diode Forward Voltage	V_{SD}	$I_S=-500mA, V_{GS}=0V$	-	-1	-1.3	V

NOTES :

1. Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.
2. Essentially independent of operating temperature typical characteristics.
3. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.
4. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
5. The maximum current rating is package limited.
6. Guaranteed by design, not subject to production testing.

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N-Channel TYPICAL CHARACTERISTIC CURVES

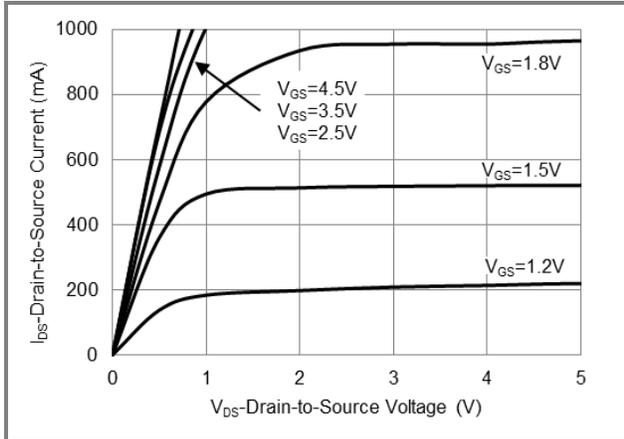


Fig.1 On-Region Characteristics

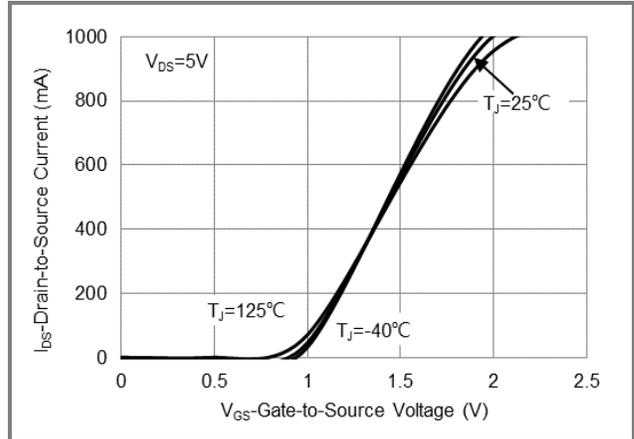


Fig.2 Transfer Characteristics

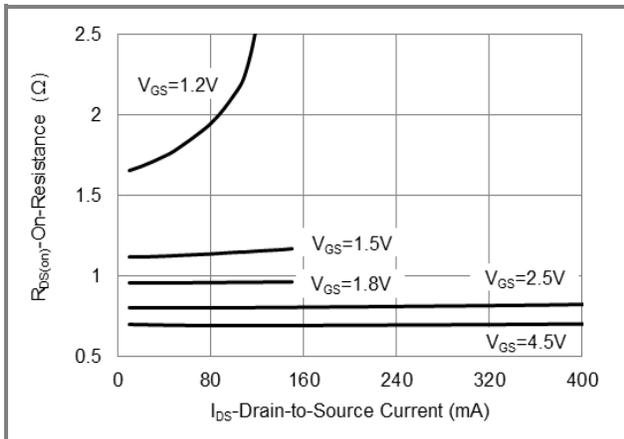


Fig.3 On-Resistance vs. Drain Current

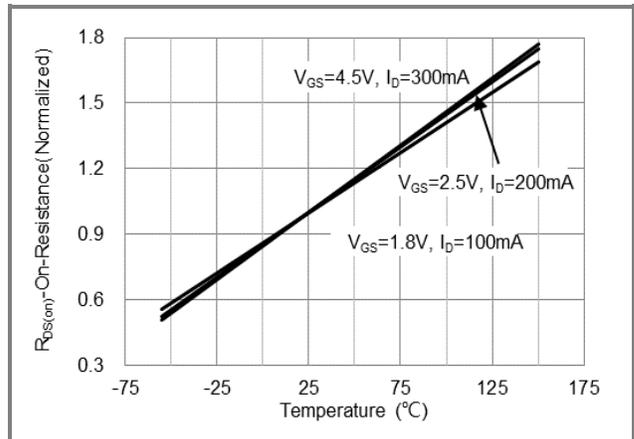


Fig.4 On-Resistance vs. Junction temperature

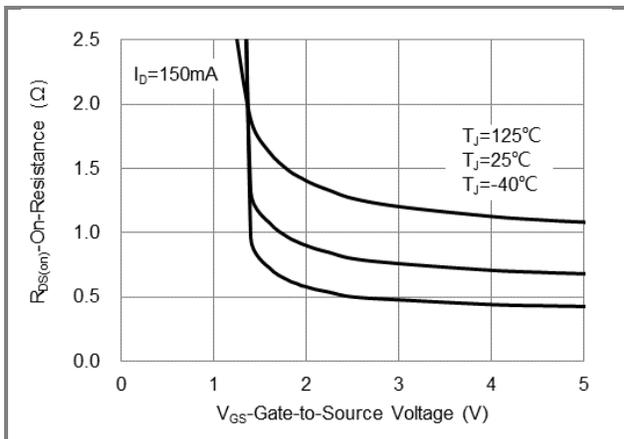


Fig.5 On-Resistance Variation with V_{GS}

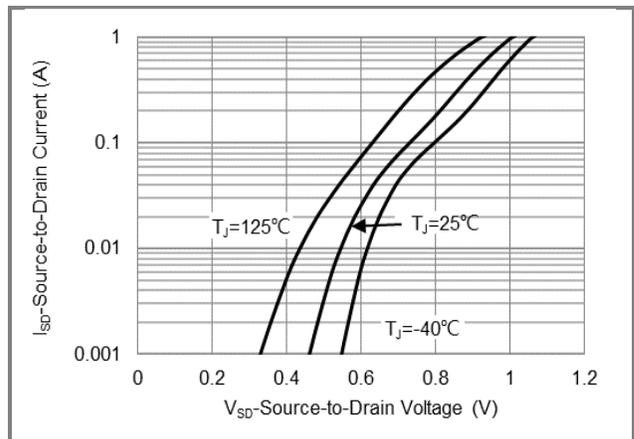


Fig.6 Body Diode Characteristics

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N-Channel TYPICAL CHARACTERISTIC CURVES

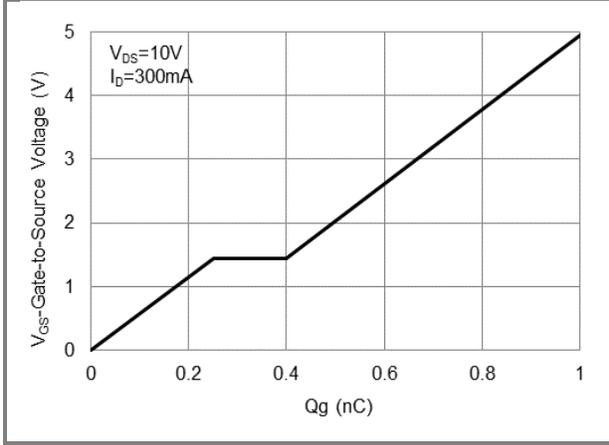


Fig.7 Gate-Charge Characteristics

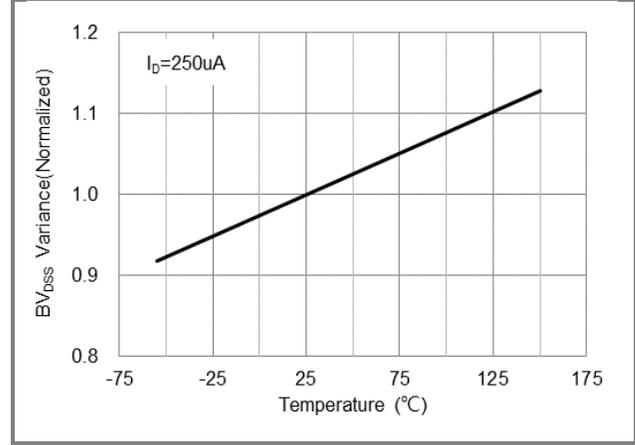


Fig.8 Breakdown Voltage Variation vs. Temperature

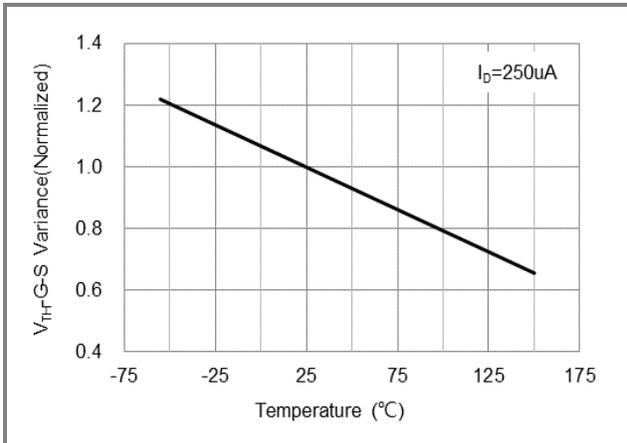


Fig.9 Threshold Voltage Variation with Temperature

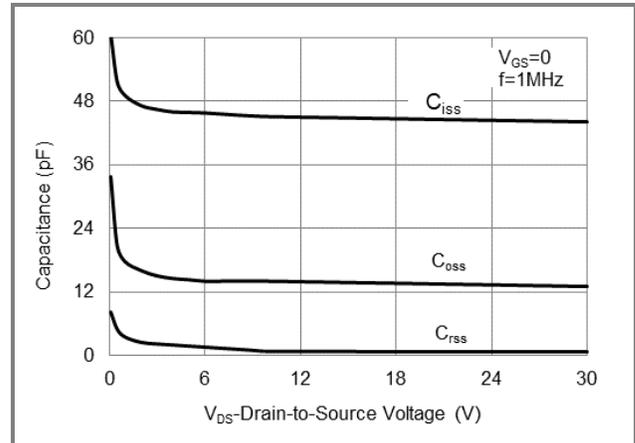


Fig.10 Capacitance vs. Drain-Source Voltage

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P-Channel TYPICAL CHARACTERISTIC CURVES

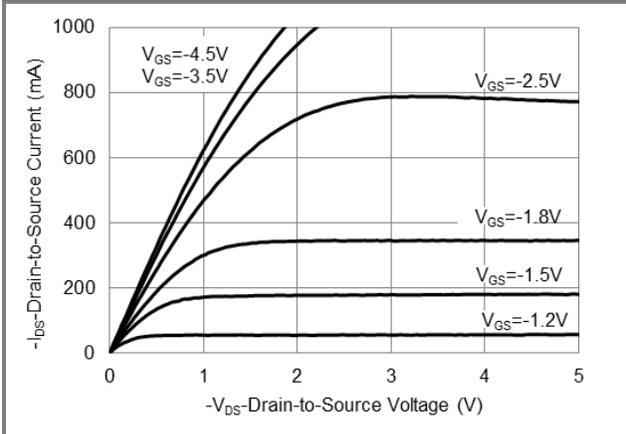


Fig.1 On-Region Characteristics

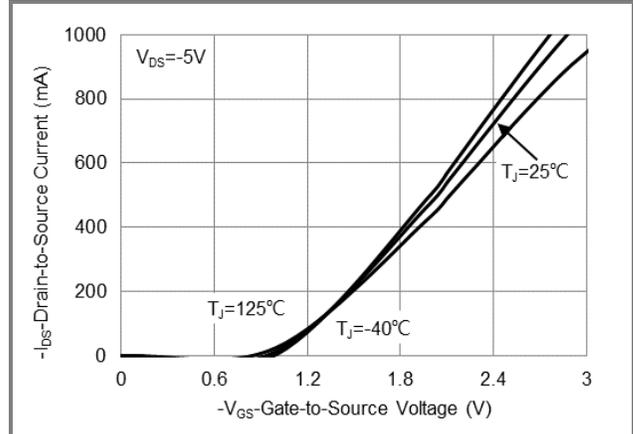


Fig.2 Transfer Characteristics

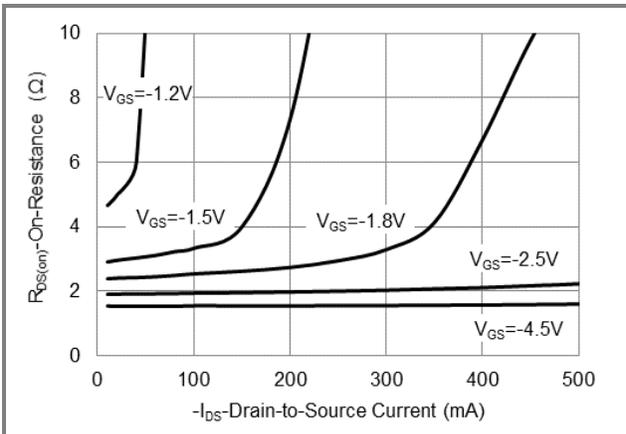


Fig.3 On-Resistance vs. Drain Current

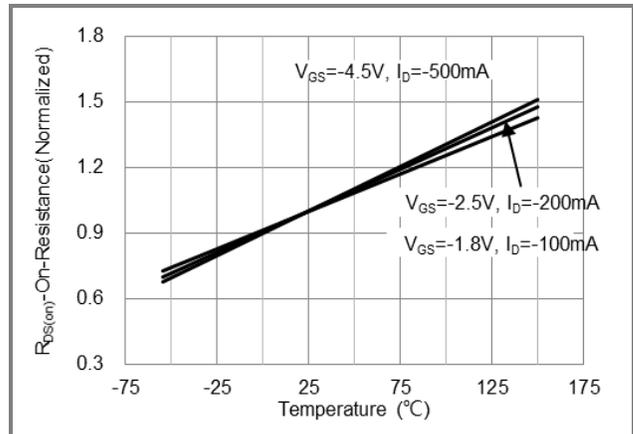


Fig.4 On-Resistance vs. Junction temperature

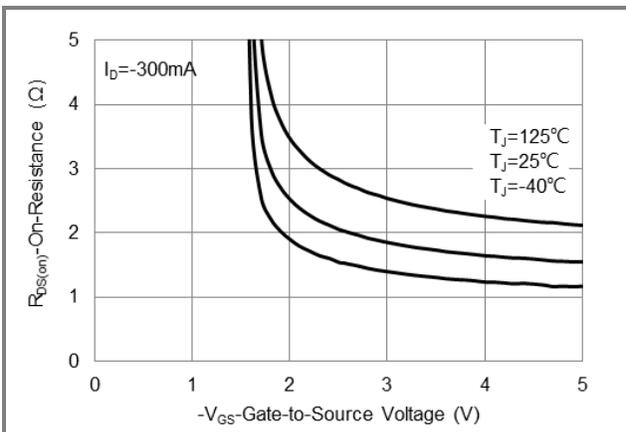


Fig.5 On-Resistance Variation with V_{GS}

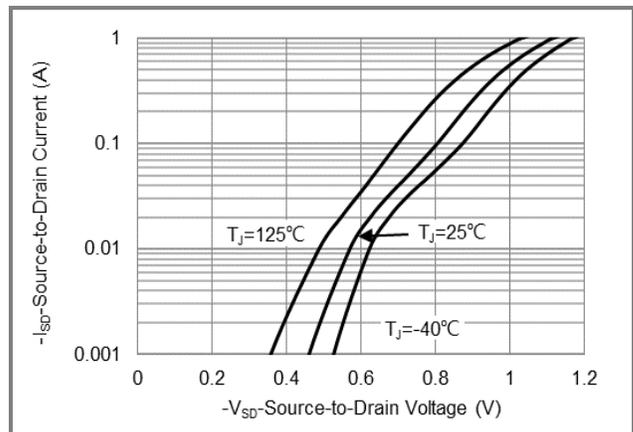
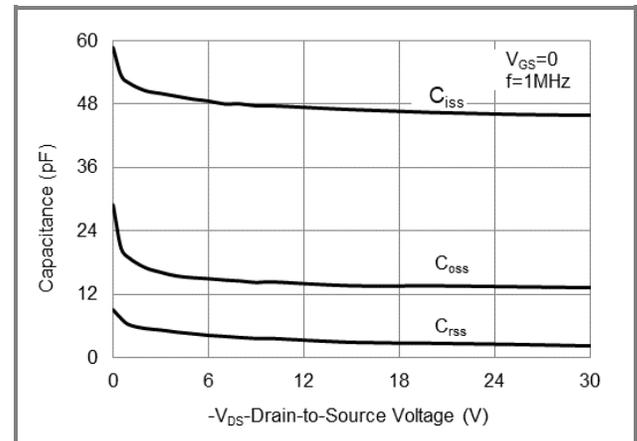
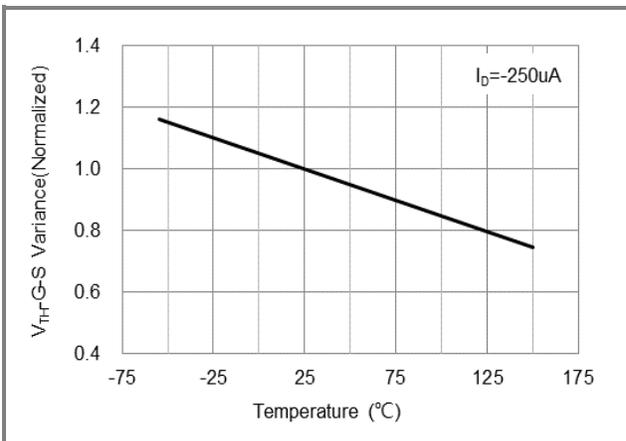
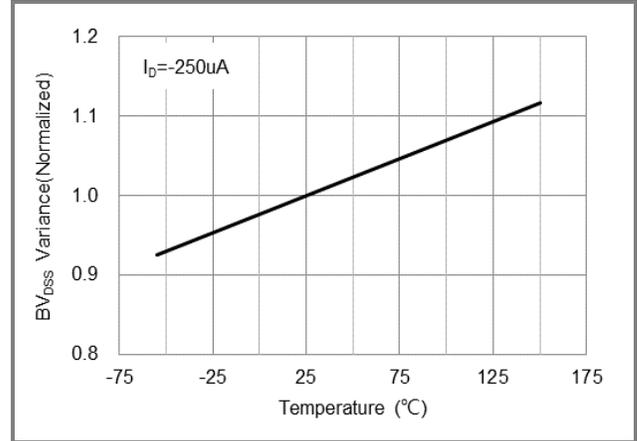
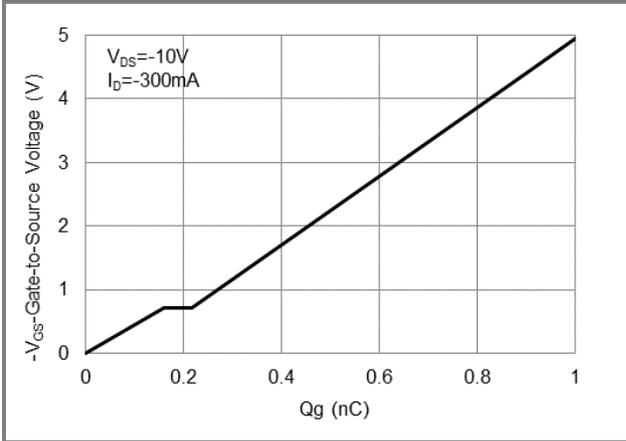


Fig.6 Body Diode Characteristics

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P-Channel TYPICAL CHARACTERISTIC CURVES

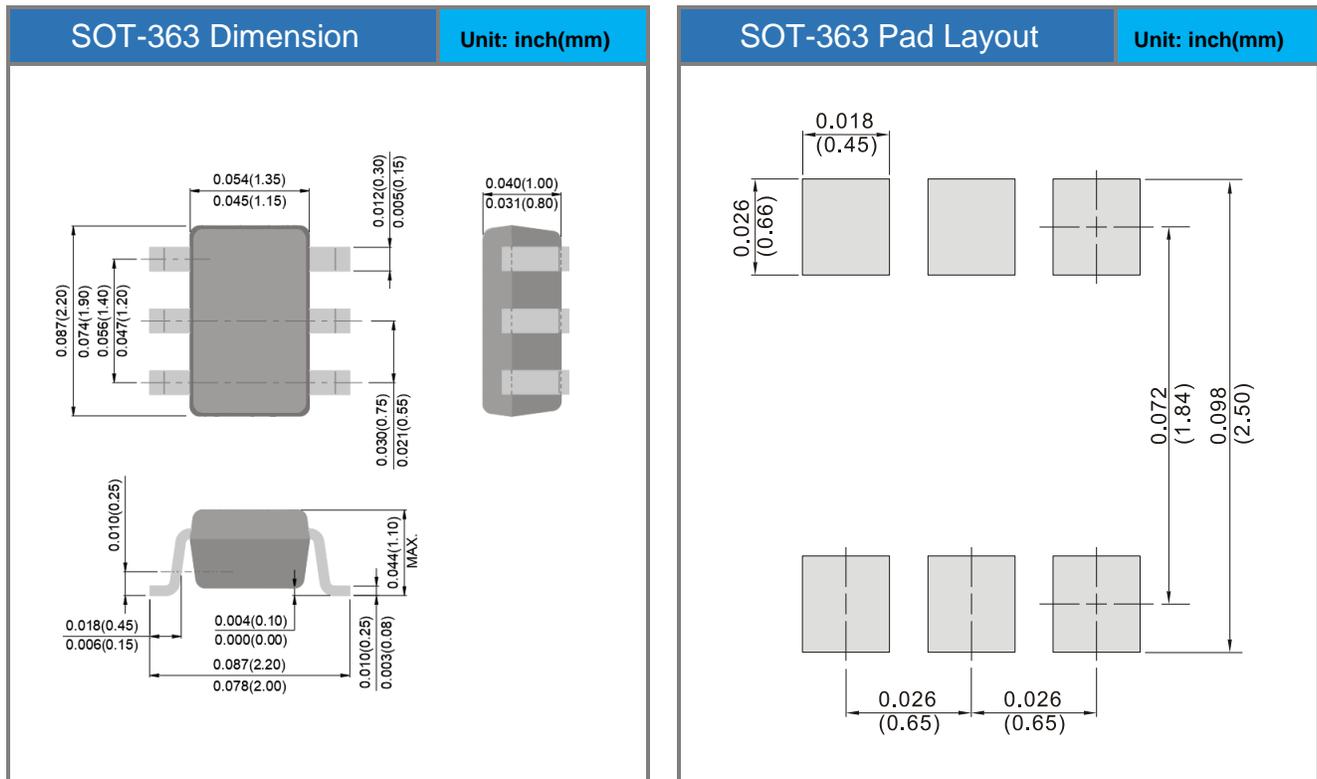


PJT7604-AU

Product and Packing Information

Part No	Package Type	Packing Type	Marking
PJT7604-AU	SOT-363	3K pcs / 7" reel	T64

Packaging Information & Mounting Pad Layout



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